AMENDMENTS TO THE CLAIMS

Listing Of Claims

Claims 1-46 (Canceled)

- 47. (currently amended) A semiconductor component comprising:
- a semiconductor die having a face and a plurality of die contacts on the face in a pattern;

an electrically insulating layer on the face;

a redistribution circuit comprising a plurality of redistribution conductors on the layer face in electrical communication with the die contacts configured to redistribute the pattern of the die contacts into an area array, and a plurality of test contacts in electrical communication with the conductors; and

an electrically insulating outer layer on the conductors and the layer having a plurality of openings aligned with selected portions of the conductors configured in an area array; and

a plurality of bumped contacts in the openings bonded to the selected portions of in the area array in electrical communication with the conductors;

the test contacts configured to permit testing of the die without electrical engagement of the bumped contacts.

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the outer layer and the openings configured as a mask for forming the bumped contacts on the selected portions and for preventing bridging between the bumped contacts.

48. (currently amended) The component of claim 47 wherein the test contacts comprise portions of the conductors.

outer layer comprises a photoimageable material.

- 49. (currently amended) The component of claim 47 wherein the redistribution circuit includes an electrically insulating layer on the conductors.

 outer layer is patterned to cover selected areas on the face of the die.
- 50. (currently amended) The component of claim 47 wherein the test contacts include non oxidizing layers.

 a depth of the openings is equal to a thickness of the outer layer minus a thickness of the conductors.
- 51. (currently amended) The component of claim 47 wherein the die has a plurality of edges and the redistribution conductors fan out the pattern of the die contacts to the edges.
- 52. (currently amended) The component of claim 47 wherein the die has a plurality of edges and the redistribution conductors fan in the pattern of the die contacts from the edges.

Claims 53-67 (canceled)